502502633 09/19/2013

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ying-Lieh Chen	01/30/2012

RECEIVING PARTY DATA

Name:	Raydium Semiconductor Corporation	
Street Address:	2F, No. 23, Li-Hsin Rd.	
Internal Address:	Hsinchu Science Park	
City:	Hsinchu	
State/Country:	/Country: TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14032036

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	FORM/0043USD1
NAME OF SUBMITTER:	Jason C. Huang
Signature:	/Jason C. Huang, Reg. No. 46222/

PATENT REEL: 031244 FRAME: 0265 _OP \$40.00 14

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Date: 09/19/2013

Total Attachments: 2
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PATENT REEL: 031244 FRAME: 0266

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

Ying-Lich Chen

7F., No.283, Shengchan Rd., East Dist., Tainan City 701, Taiwan (R.O.C.)

(hereinafter referred to as Assignors), have invented a certain invention entitled:

Level Shifter

Enclosed herewith or for which application for Letters Patent in the United States was filed on: (a) February 1, 2012, under Serial No. 13/363.750

WHEREAS, Raydlum Semiconductor Corporation, a corporation of Talwan, Republic of China, having a place of business at <u>2F. No.23. Li-Hsin Rd., Hsinchu Science Park, Hsinchu 300, Talwan, R.O.C.</u> (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said invention in any and all countries pursuant to the international Convention for the Protection of industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignes hereby covenant and agree to cooperate with said Assignes to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or destrable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filling and prosecuting substitute, conventional, divisional, continuing or additional applications covering said invention; (d) for filling and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation

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shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.
- 5. In the event that the filing date and/or Application No. of said Invention are not entered above at the time Assignors execute this document, and if such information is deemed necessary, Assignors hereby authorize and request the attorney/agent(s) of Patterson & Sheridan, LLP, 595 Shrewsbury Avenue, Suite 100, Shrewsbury, NJ 07702 to insert above the filing date and/or Application No. of said application.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

>012.01.30 (DATE) Tring-Lieh, Chen

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RECORDED: 09/19/2013